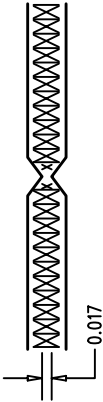


- NOTES : Unless Otherwise Specified**
- 1. MATERIAL : FR4 OR EQUIVALENT EPOXY, 2 OZ. COPPER CLAD
THICKNESS .062 +/--.006 TOTAL OF 4 LAYERS
 - 2. FINISH : ALL PLATED HOLES .001 MIN. / .0015 MAX. COPPER PLATE
ELECTRODEPOSITED TIN-LEAD COMPOSITION
BEFORE REFLOW , SOLDER MASK OVER BARE COPPER (SM08C)
 - 3. SOLDER MASK : BOTH SIDES USING LPI
 - 4. SILKSCREEN : USING WHITE NON-CONDUCTIVE EPOXY INK
 - 5. ALL DIMENSIONS ARE IN INCHES
 - 6. SCORING:



SIZE	QTY	SYM	PLTD
40	6		PLTD
15	21	X	PLTD
72	2	Y	NPLTD
95	7	Z	PLTD

Fabrication Drawing